



40V +175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D T _C = +25°C (Note 7)
40V	$3.3 \text{m}\Omega @ V_{GS} = 10V$	100A
40 V	$5.0 \text{m}\Omega$ @ V _{GS} = 5V	95A

Description

This new generation N-channel enhancement mode MOSFET is designed to minimize $R_{\text{DS(ON)}}$ yet maintain superior switching performance.

Applications

- BLDC motors
- DC-DC converters
- Load switches

PowerDI5060-8/SWP (Type UX)



Features

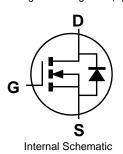
- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Ensures More Reliable And Robust End Application
- Low RDS(ON) Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.

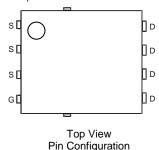
https://www.diodes.com/quality/product-definitions/

An automotive-compliant part is available under separate datasheet (DMTH43M8LPSWQ)

Mechanical Data

- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.097 grams (Approximate)





Ordering Information (Note 4)

Top View

- 7					
	Orderable Part Number	Package	Packing		
	Orderable Part Number	Fackage	Qty.	Carrier	
	DMTH43M8LPSW-13	PowerDI5060-8/SWP (Type UX)	2500	Tape & Reel	

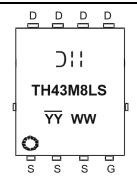
Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Bottom View

7. Package limit.

Marking Information



TH43M8LS = Product Type Marking Code

YYWW = Date Code Marking

YY = Last Two Digits of Year (ex: 24 = 2024)

WW = Week Code (01 to 53)



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	VDSS	40	V	
Gate-Source Voltage	V_{GSS}	±20	V	
Continuous Drain Current, Vgs = 10V (Note 5)	$T_A = +25^{\circ}C$ $T_A = +100^{\circ}C$	ID	22 15.5	А
Continuous Drain Current, V _{GS} = 10V (Notes 6 & 7)	T _C = +25°C T _C = +100°C	ID	100 82	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	350	Α	
Maximum Continuous Body Diode Forward Current (Note 6	ls	69	Α	
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cyc	I _{SM}	350	A	
Avalanche Current, L = 1mH	las	13.2	А	
Avalanche Energy, L = 1mH	Eas	87	mJ	

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	2.7	W
Thermal Resistance, Junction to Ambient (Note 5)		Reja	55	°C/W
Total Power Dissipation (Note 6)	Tc = +25°C	PD	83	W
Thermal Resistance, Junction to Case (Note 6)		Rелс	1.8	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate. 6. Thermal resistance from junction to soldering point (on the exposed drain pad). Notes:

7. Package limit.

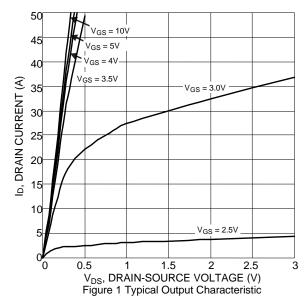
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

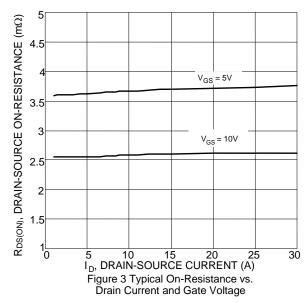
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	40	_	_	V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μΑ	V _{DS} = 32V, V _{GS} = 0V	
Gate-Source Leakage	Igss	_	_	±100	nA $V_{GS} = \pm 20V$, $V_{DS} = 0V$		
ON CHARACTERISTICS (Note 8)	ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	Vgs(th)	1	_	2.5	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	D	_	2.7	3.3	mΩ	$V_{GS} = 10V, I_D = 20A$	
Static Drain-Source On-Resistance	RDS(ON)	_	3.6	5.0	11122	V _G S = 5V, I _D = 15A	
Diode Forward Voltage	V _{SD}			1.2	V	V _{GS} = 0V, I _S = 20A	
DYNAMIC CHARACTERISTICS (Note 9)			•	•	•	•	
Input Capacitance	C _{iss}	_	2693	_		V _{DS} = 20V, V _{GS} = 0V, f = 1MHz	
Output Capacitance	Coss	_	1172	_	pF		
Reverse Transfer Capacitance	Crss	_	52	_			
Gate Resistance	Rg	_	2.54	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 10V)	QG	_	38.5	_		V _{DS} = 20V, I _D = 20A	
Total Gate Charge (V _{GS} = 4.5V)	QG	_	17.6	_	nC		
Gate-Source Charge	Qgs		6.9	_	nc nc		
Gate-Drain Charge	Q _{GD}		6.9	_			
Turn-On Delay Time	t _{D(ON)}		5.2	_		$V_{DD} = 20V, V_{GS} = 10V,$ $I_{D} = 20A, R_{G} = 3\Omega$	
Turn-On Rise Time	t _R		5.7	_			
Turn-Off Delay Time	tD(OFF)	_	23.5	_	ns		
Turn-Off Fall Time	t _F	_	11	_			
Body Diode Reverse-Recovery Time	trr	_	35.4	_	ns	1 004 11/11 4004/	
Body Diode Reverse-Recovery Charge	Q _{RR}	_	32.9	_	nC	I _F = 20A, di/dt = 100A/μs	

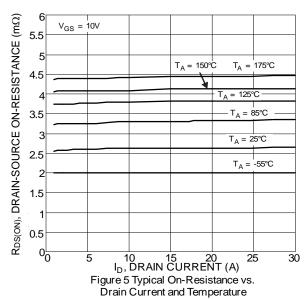
8. Short duration pulse test used to minimize self-heating effect. 9. Guaranteed by design. Not subject to product testing. Notes:

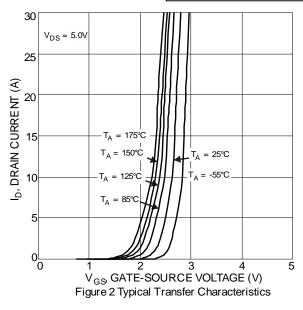


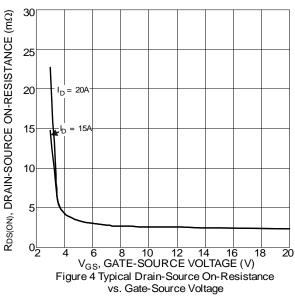












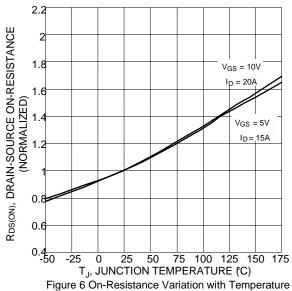


Figure 6 On-Resistance Variation with Temperature

DMTH43M8LPSW



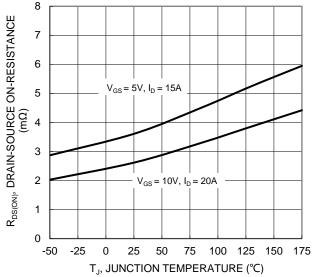
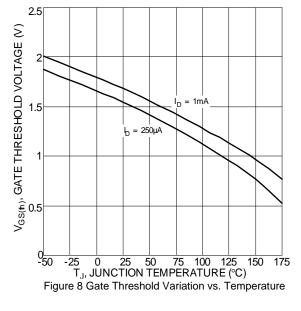
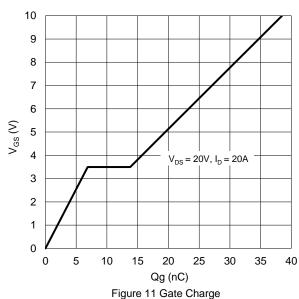


Figure 7 On-Resistance Variation with Temperature





10000 f = 1MHzC_T, JUNCTION CAPACITANCE (pF) C_{iss} 1000 100 Crss 10 0 5 10 15 20 25 30 35 40 V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 10 Typical Junction Capacitance

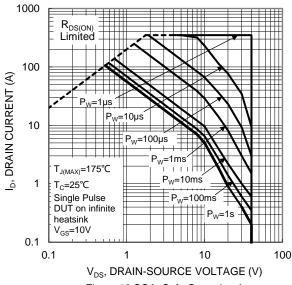
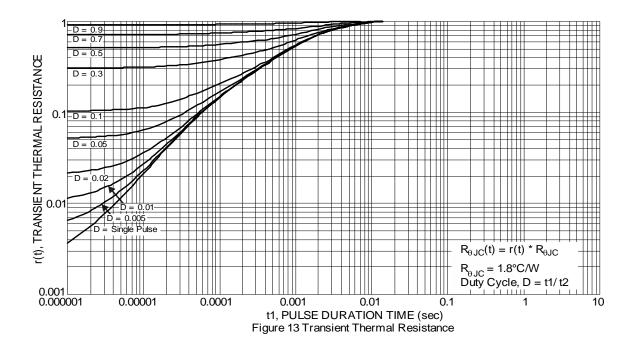


Figure 12 SOA, Safe Operation Area



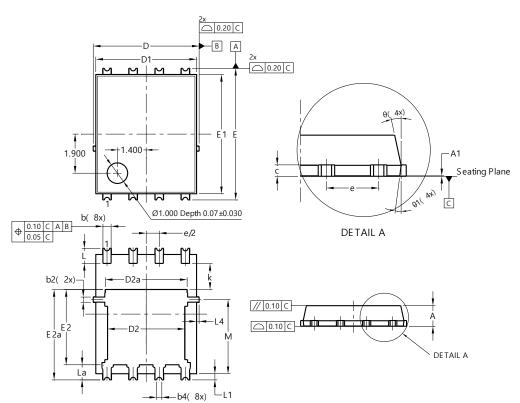




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8/SWP (Type UX)

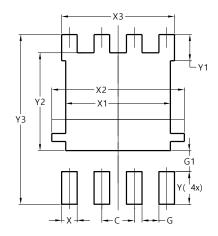


Ро	PowerDI5060-8/SWP (Type UX)				
Dim	Min Max		Тур		
Α	0.90	1.10	1.00		
A1	0	0.05			
b	0.30	0.50	0.41		
b2	0.20	0.35	0.25		
b4	0.25REF				
С	0.230	0.330	0.277		
D	5.15 BSC				
D1	4.70	5.10	4.90		
D2	3.56	3.96	3.76		
D2a	3.78	4.18	3.98		
Е	6.40 BSC				
E1	5.60 6.00		5.80		
E2	3.46	3.86	3.66		
E2a	4.195	4.595	4.395		
е	1	.27BSC)		
k	1.05				
L	0.635	0.835	0.735		
La	0.635	0.835	0.735		
L1	0.200	0.400	0.300		
L4	0.025	0.225	0.125		
M	3.205	4.005	3.605		
θ	10°	12°	11°		
θ1	6°	8°	7°		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8/SWP (Type UX)



Dimensions	Value		
Dillielisions	(in mm)		
С	1.270		
G	0.660		
G1	0.820		
X	0.610		
X1	4.100		
X2	5.190		
Х3	4.420		
Υ	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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